

Handwritten notes: #20, RGA, 12400

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. 09/141,775  
Priority Filing Date August 27, 1998  
Inventor Guy T. Blalock et al.  
Priority Group Art Unit 1765  
Priority Examiner L. Vinh  
Attorney's Docket No. MI22-1544  
Title: Plasma Etching Methods

PRELIMINARY AMENDMENT

To: Box Patent Application  
Assistant Commissioner for Patents  
Washington, D.C. 20231

From: Bernard Berman (Tel. 509-624-4276; Fax 509-838-3424)  
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Sir:

Please enter the following amendments prior to examining the above-identified application.

AMENDMENTS

In the Specification

At p. 1, before the "Technical Field" section, please replace the existing Related Applications section with the following:

--RELATED PATENT DATA

This patent is a continuation application of U.S. Patent Application Serial No. 09/141,775, which was filed on August 27, 1998, entitled "Plasma Etching Methods," naming Guy T. Blalock, David S. Becker, and

Handwritten notes: C1, Sub 1